

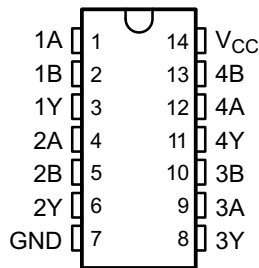
## QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES

Check for Samples: [SN54AHC86](#), [SN74AHC86](#)

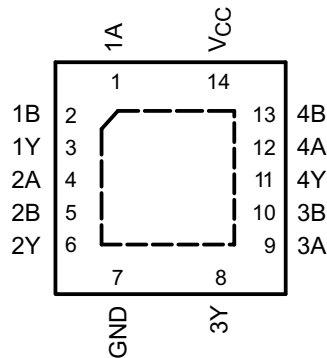
### FEATURES

- Operating Range 2-V to 5.5-V  $V_{CC}$
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

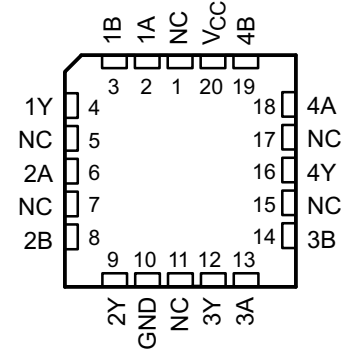
SN54AHC86 . . . J OR W PACKAGE  
SN74AHC86 . . . D, DB, DGV, N, NS,  
OR PW PACKAGE  
(TOP VIEW)



SN74AHC86 . . . RGY PACKAGE  
(TOP VIEW)



SN54AHC86 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

### DESCRIPTION

The 'AHC86 devices are quadruple 2-input exclusive-OR gates. These devices perform the Boolean function  $Y = A \oplus B$  or  $Y = \bar{A}B + A\bar{B}$  in positive logic.

A common application is as a true/complement element. If one of the inputs is low, the other input is reproduced in true form at the output. If one of the inputs is high, the signal on the other input is reproduced inverted at the output.

FUNCTION TABLE  
(EACH GATE)

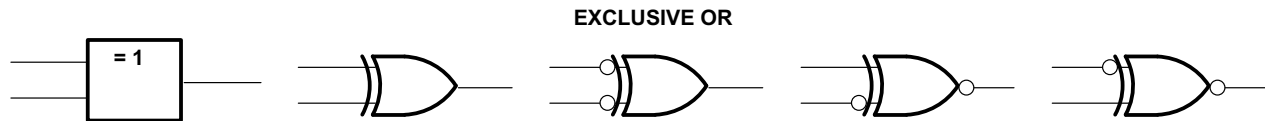
| INPUTS |   | OUTPUT |
|--------|---|--------|
| A      | B | Y      |
| L      | L | L      |
| L      | H | H      |
| H      | L | H      |
| H      | H | L      |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

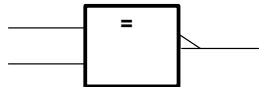
## EXCLUSIVE-OR LOGIC

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.



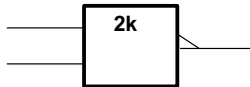
These are five equivalent exclusive-OR symbols valid for an SN74AHC86 gate in positive logic; negation may be shown at any two ports.

### LOGIC-IDENTITY ELEMENT



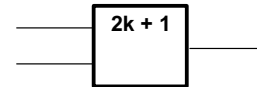
The output is active (low) if all inputs stand at the same logic level (i.e.,  $A = B$ ).

### EVEN-PARITY ELEMENT



The output is active (low) if an even number of inputs (i.e., 0 or 2) are active.

### ODD-PARITY ELEMENT



The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active.

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                                |                            | VALUE                  | UNIT |
|----------------------------------------------------------------|----------------------------|------------------------|------|
| Supply voltage range, $V_{CC}$                                 |                            | -0.5 to 7              | V    |
| Input voltage range, $V_I$ <sup>(2)</sup>                      |                            | -0.5 to 7              | V    |
| Output voltage range, $V_O$ <sup>(2)</sup>                     |                            | -0.5 to $V_{CC} + 0.5$ | V    |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                    |                            | -20                    | mA   |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) |                            | ±20                    | mA   |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )     |                            | ±25                    | mA   |
| Continuous current through $V_{CC}$ or GND                     |                            | ±50                    | mA   |
| Package thermal impedance, $\theta_{JA}$                       | D package <sup>(3)</sup>   | 86                     | °C/W |
|                                                                | DB package <sup>(3)</sup>  | 96                     |      |
|                                                                | DGV package <sup>(3)</sup> | 127                    |      |
|                                                                | N package <sup>(3)</sup>   | 80                     |      |
|                                                                | NS package <sup>(3)</sup>  | 76                     |      |
|                                                                | PW package <sup>(3)</sup>  | 113                    |      |
|                                                                | RGY package <sup>(4)</sup> | 47                     |      |
| Storage temperature range, $T_{stg}$                           |                            | -65 to 150             | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.
- (4) The package thermal impedance is calculated in accordance with JESD 51-5

**RECOMMENDED OPERATING CONDITIONS<sup>(1)</sup>**

|                 |                                    |                                 | SN54AHC86 |                 | SN74AHC86 |                 | UNIT |
|-----------------|------------------------------------|---------------------------------|-----------|-----------------|-----------|-----------------|------|
|                 |                                    |                                 | MIN       | MAX             | MIN       | MAX             |      |
| V <sub>CC</sub> | Supply voltage                     |                                 | 2         | 5.5             | 2         | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 2 V           | 1.5       |                 | 1.5       |                 | V    |
|                 |                                    | V <sub>CC</sub> = 3 V           | 2.1       |                 | 2.1       |                 |      |
|                 |                                    | V <sub>CC</sub> = 5.5 V         | 3.85      |                 | 3.85      |                 |      |
| V <sub>IL</sub> | Low-level Input voltage            | V <sub>CC</sub> = 2 V           |           | 0.5             |           | 0.5             | V    |
|                 |                                    | V <sub>CC</sub> = 3 V           |           | 0.9             |           | 0.9             |      |
|                 |                                    | V <sub>CC</sub> = 5.5 V         |           | 1.65            |           | 1.65            |      |
| V <sub>I</sub>  | Input voltage                      |                                 | 0         | 5.5             | 0         | 5.5             | V    |
| V <sub>O</sub>  | Output voltage                     |                                 | 0         | V <sub>CC</sub> | 0         | V <sub>CC</sub> | V    |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 2 V           |           | –50             |           | –50             | mA   |
|                 |                                    | V <sub>CC</sub> = 3.3 V ± 0.3 V |           | –4              |           | –4              |      |
|                 |                                    | V <sub>CC</sub> = 5 V ± 0.5 V   |           | –8              |           | –8              |      |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 2 V           |           | 50              |           | 50              | mA   |
|                 |                                    | V <sub>CC</sub> = 3.3 V ± 0.3 V |           | 4               |           | 4               |      |
|                 |                                    | V <sub>CC</sub> = 5 V ± 0.5 V   |           | 8               |           | 8               |      |
| Δt/Δv           | Input Transition rise or fall rate | V <sub>CC</sub> = 3.3 V ± 0.3 V |           | 100             |           | 100             | ns/V |
|                 |                                    | V <sub>CC</sub> = 5 V ± 0.5 V   |           | 20              |           | 20              |      |
| T <sub>A</sub>  | Operating free-air temperature     |                                 | –55       | 125             | –40       | 125             | °C   |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number [SCBA004](#).

## ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS                                             | V <sub>CC</sub> | T <sub>A</sub> = 25°C |      |      | T <sub>A</sub> = –55°C TO 125°C |      | T <sub>A</sub> = –40°C TO 85°C |      | T <sub>A</sub> = –40°C TO 125°C |     | UNIT |
|-----------------|-------------------------------------------------------------|-----------------|-----------------------|------|------|---------------------------------|------|--------------------------------|------|---------------------------------|-----|------|
|                 |                                                             |                 |                       |      |      |                                 |      |                                |      | Recommended                     |     |      |
|                 |                                                             |                 | MIN                   | TYP  | MAX  | MIN                             | MAX  | MIN                            | MAX  | MIN                             | MAX |      |
| V <sub>OH</sub> | I <sub>OH</sub> = –50 μA                                    | 2 V             | 1.9                   | 2    |      | 1.9                             |      | 1.9                            |      | 1.9                             | V   |      |
|                 |                                                             | 3 V             | 2.9                   | 3    |      | 2.9                             |      | 2.9                            |      | 2.9                             |     |      |
|                 |                                                             | 4.5 V           | 4.4                   | 4.5  |      | 4.4                             |      | 4.4                            |      | 4.4                             |     |      |
|                 | I <sub>OH</sub> = –4 mA                                     | 3 V             | 2.58                  |      | 2.48 |                                 | 2.48 |                                | 2.48 |                                 |     |      |
|                 | I <sub>OH</sub> = –8 mA                                     | 4.5 V           | 3.94                  |      | 3.8  |                                 | 3.8  |                                | 3.8  |                                 |     |      |
| V <sub>OL</sub> | I <sub>OL</sub> = 50 μA                                     | 2 V             |                       | 0.1  |      | 0.1                             |      | 0.1                            |      | 0.1                             | V   |      |
|                 |                                                             | 3 V             |                       | 0.1  |      | 0.1                             |      | 0.1                            |      | 0.1                             |     |      |
|                 |                                                             | 4.5 V           |                       | 0.1  |      | 0.1                             |      | 0.1                            |      | 0.1                             |     |      |
|                 | I <sub>OH</sub> = 4 mA                                      | 3 V             |                       | 0.36 |      | 0.5                             |      | 0.44                           |      | 0.5                             |     |      |
|                 | I <sub>OH</sub> = 8 mA                                      | 4.5 V           |                       | 0.36 |      | 0.5                             |      | 0.44                           |      | 0.5                             |     |      |
| I <sub>I</sub>  | V <sub>I</sub> = 5.5 V or GND                               | 0 V to 5.5 V    |                       | ±0.1 |      | ±1 <sup>(1)</sup>               |      | ±1                             |      | ±1                              | μA  |      |
| I <sub>CC</sub> | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 5.5 V           |                       | 2    |      | 20                              |      | 20                             |      | 20                              | μA  |      |
| C <sub>i</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 5 V             |                       | 4    | 10   |                                 |      |                                | 10   |                                 |     | pF   |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested at V<sub>CC</sub> = 0 V.

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE    | T <sub>A</sub> = 25°C |                   | T <sub>A</sub> = –55°C TO<br>125°C |                   | T <sub>A</sub> = –40°C TO<br>85°C |      | T <sub>A</sub> = –40°C TO<br>125°C |      | UNIT |
|------------------|-----------------|----------------|------------------------|-----------------------|-------------------|------------------------------------|-------------------|-----------------------------------|------|------------------------------------|------|------|
|                  |                 |                |                        |                       |                   |                                    |                   |                                   |      | Recommended                        |      |      |
|                  |                 |                |                        |                       |                   | SN54AHC86                          |                   | SN74AHC86                         |      | SN74AHC86                          |      |      |
|                  |                 |                |                        | TYP                   | MAX               | MIN                                | MAX               | MIN                               | MAX  | MIN                                | MAX  |      |
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 15 pF | 7 <sup>(1)</sup>      | 11 <sup>(1)</sup> | 1 <sup>(1)</sup>                   | 13 <sup>(1)</sup> | 1                                 | 13   | 1                                  | 13   | ns   |
| t <sub>PHL</sub> |                 |                |                        | 7 <sup>(1)</sup>      | 11 <sup>(1)</sup> | 1 <sup>(1)</sup>                   | 13 <sup>(1)</sup> | 1                                 | 13   | 1                                  | 13   |      |
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 50 pF | 9.5                   | 14.5              | 1                                  | 16.5              | 1                                 | 16.5 | 1                                  | 16.5 | ns   |
| t <sub>PHL</sub> |                 |                |                        | 9.5                   | 14.5              | 1                                  | 16.5              | 1                                 | 16.5 | 1                                  | 16.5 |      |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE    | T <sub>A</sub> = 25°C |                    | T <sub>A</sub> = –55°C TO<br>125°C |                  | T <sub>A</sub> = –40°C TO<br>85°C |     | T <sub>A</sub> = –40°C TO<br>125°C |     | UNIT |
|------------------|-----------------|----------------|------------------------|-----------------------|--------------------|------------------------------------|------------------|-----------------------------------|-----|------------------------------------|-----|------|
|                  |                 |                |                        |                       |                    | SN54AHC86                          |                  | SN74AHC86                         |     | SN74AHC86                          |     |      |
|                  |                 |                |                        | TYP                   | MAX                | MIN                                | MAX              | MIN                               | MAX | MIN                                | MAX |      |
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 15 pF | 4.8 <sup>(1)</sup>    | 6.8 <sup>(1)</sup> | 1 <sup>(1)</sup>                   | 8 <sup>(1)</sup> | 1                                 | 8   | 1                                  | 8   | ns   |
| t <sub>PHL</sub> |                 |                |                        | 4.8 <sup>(1)</sup>    | 6.8 <sup>(1)</sup> | 1 <sup>(1)</sup>                   | 8 <sup>(1)</sup> | 1                                 | 8   | 1                                  | 8   |      |
| t <sub>PLH</sub> | A or B          | Y              | C <sub>L</sub> = 50 pF | 6.3                   | 8.8                | 1                                  | 10               | 1                                 | 10  | 1                                  | 10  | ns   |
| t <sub>PHL</sub> |                 |                |                        | 6.3                   | 8.8                | 1                                  | 10               | 1                                 | 10  | 1                                  | 10  |      |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

## NOISE CHARACTERISTICS

 $V_{CC} = 5\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}^{(1)}$ 

| PARAMETER   |                                        | SN74AHC86 |      |      | UNIT |
|-------------|----------------------------------------|-----------|------|------|------|
|             |                                        | MIN       | TYP  | MAX  |      |
| $V_{OL(P)}$ | Quiet output, maximum dynamic $V_{OL}$ |           | 0.3  | 0.8  | V    |
| $V_{OL(V)}$ | Quiet output, minimum dynamic $V_{OL}$ |           | –0.3 | –0.8 | V    |
| $V_{OH(V)}$ | Quiet output, minimum dynamic $V_{OH}$ |           | 4.4  |      | V    |
| $V_{IH(D)}$ | High-level dynamic input voltage       |           | 3.5  |      | V    |
| $V_{IL(D)}$ | Low-level dynamic input voltage        |           |      | 1.5  | V    |

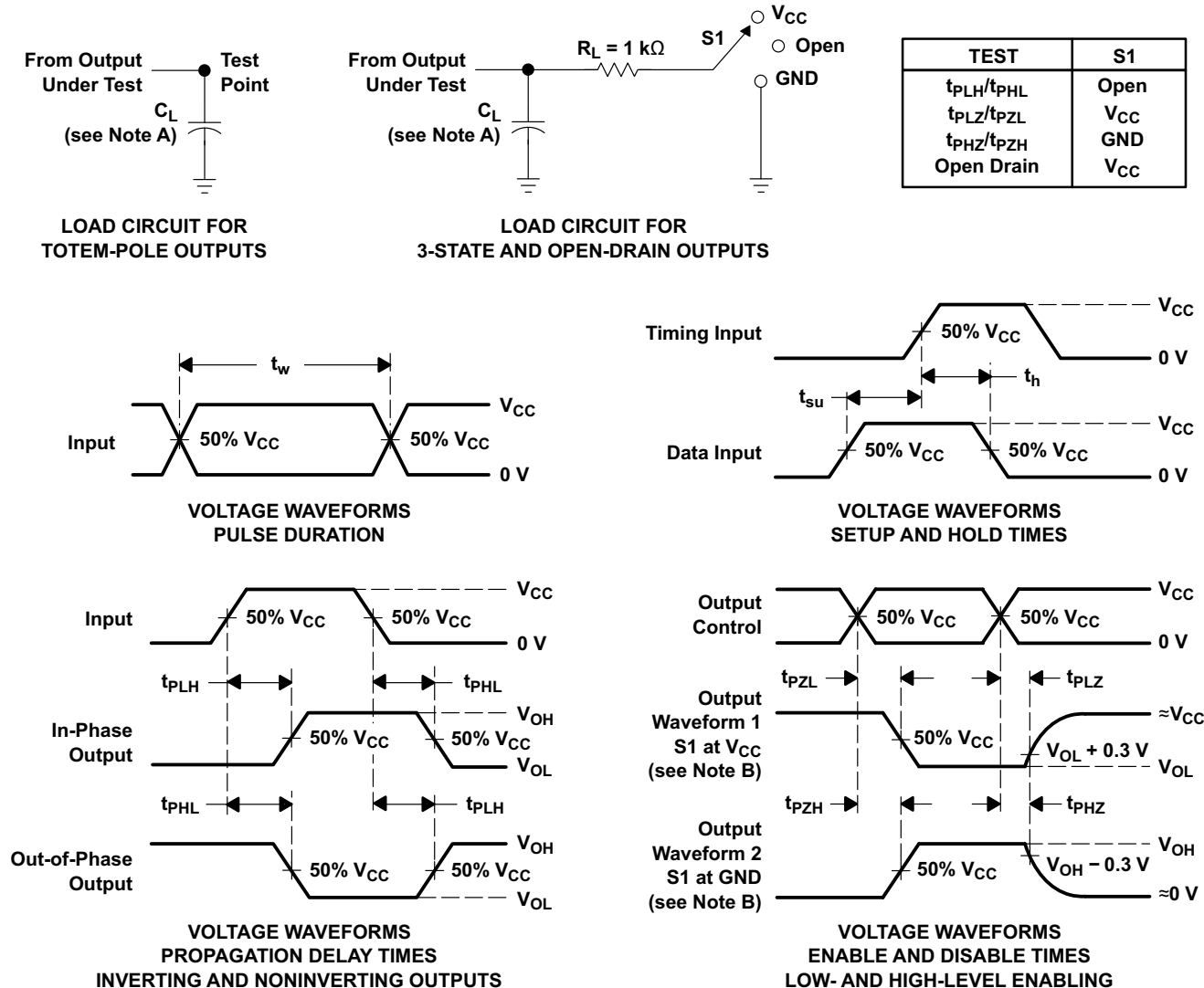
(1) Characteristics are for surface-mount packages only.

## OPERATING CHARACTERISTICS

 $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ 

| PARAMETER |                               | TEST CONDITIONS |                    | TYP | UNIT |
|-----------|-------------------------------|-----------------|--------------------|-----|------|
| $C_{pd}$  | Power dissipation capacitance | No load,        | $f = 1\text{ MHz}$ | 18  | pF   |

## PARAMETER MEASUREMENT INFORMATION



- A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.  
Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

**Figure 1. Load Circuit and Voltage Waveforms**

## REVISION HISTORY

| Changes from Revision I (July 2003) to Revision J           | Page              |
|-------------------------------------------------------------|-------------------|
| • Changed document format from Quicksilver to DocZone. .... | <a href="#">1</a> |
| • Extended operating temperature range to 125°C .....       | <a href="#">3</a> |

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                 | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-----------------------------------------|-------------------------|
| 5962-9681601Q2A  | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-<br>9681601Q2A<br>SNJ54AHC<br>86FK | <a href="#">Samples</a> |
| 5962-9681601QCA  | ACTIVE        | CDIP         | J                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9681601QC<br>A<br>SNJ54AHC86J      | <a href="#">Samples</a> |
| 5962-9681601QDA  | ACTIVE        | CFP          | W                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9681601QD<br>A<br>SNJ54AHC86W      | <a href="#">Samples</a> |
| SN74AHC86DBR     | ACTIVE        | SSOP         | DB                 | 14   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | HA86                                    | <a href="#">Samples</a> |
| SN74AHC86DGVR    | ACTIVE        | TVSOP        | DGV                | 14   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | HA86                                    | <a href="#">Samples</a> |
| SN74AHC86DR      | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AHC86                                   | <a href="#">Samples</a> |
| SN74AHC86N       | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | -40 to 125   | SN74AHC86N                              | <a href="#">Samples</a> |
| SN74AHC86NSR     | ACTIVE        | SO           | NS                 | 14   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AHC86                                   | <a href="#">Samples</a> |
| SN74AHC86PWR     | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | HA86                                    | <a href="#">Samples</a> |
| SN74AHC86PWRG4   | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | HA86                                    | <a href="#">Samples</a> |
| SN74AHC86RGYR    | ACTIVE        | VQFN         | RGY                | 14   | 3000           | RoHS & Green        | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 125   | HA86                                    | <a href="#">Samples</a> |
| SNJ54AHC86FK     | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-<br>9681601Q2A<br>SNJ54AHC<br>86FK | <a href="#">Samples</a> |
| SNJ54AHC86J      | ACTIVE        | CDIP         | J                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9681601QC<br>A<br>SNJ54AHC86J      | <a href="#">Samples</a> |
| SNJ54AHC86W      | ACTIVE        | CFP          | W                  | 14   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9681601QD<br>A<br>SNJ54AHC86W      | <a href="#">Samples</a> |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF SN54AHC86, SN74AHC86 :**

- Catalog : [SN74AHC86](#)
- Military : [SN54AHC86](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AHC86DBR  | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| SN74AHC86DGVR | TVSOP        | DGV             | 14   | 2000 | 330.0              | 12.4               | 6.8     | 4.0     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74AHC86DR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74AHC86NSR  | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| SN74AHC86PWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74AHC86RGYR | VQFN         | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHC86DBR  | SSOP         | DB              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74AHC86DGVR | TVSOP        | DGV             | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74AHC86DR   | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |
| SN74AHC86NSR  | SO           | NS              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74AHC86PWR  | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74AHC86RGYR | VQFN         | RGY             | 14   | 3000 | 356.0       | 356.0      | 35.0        |

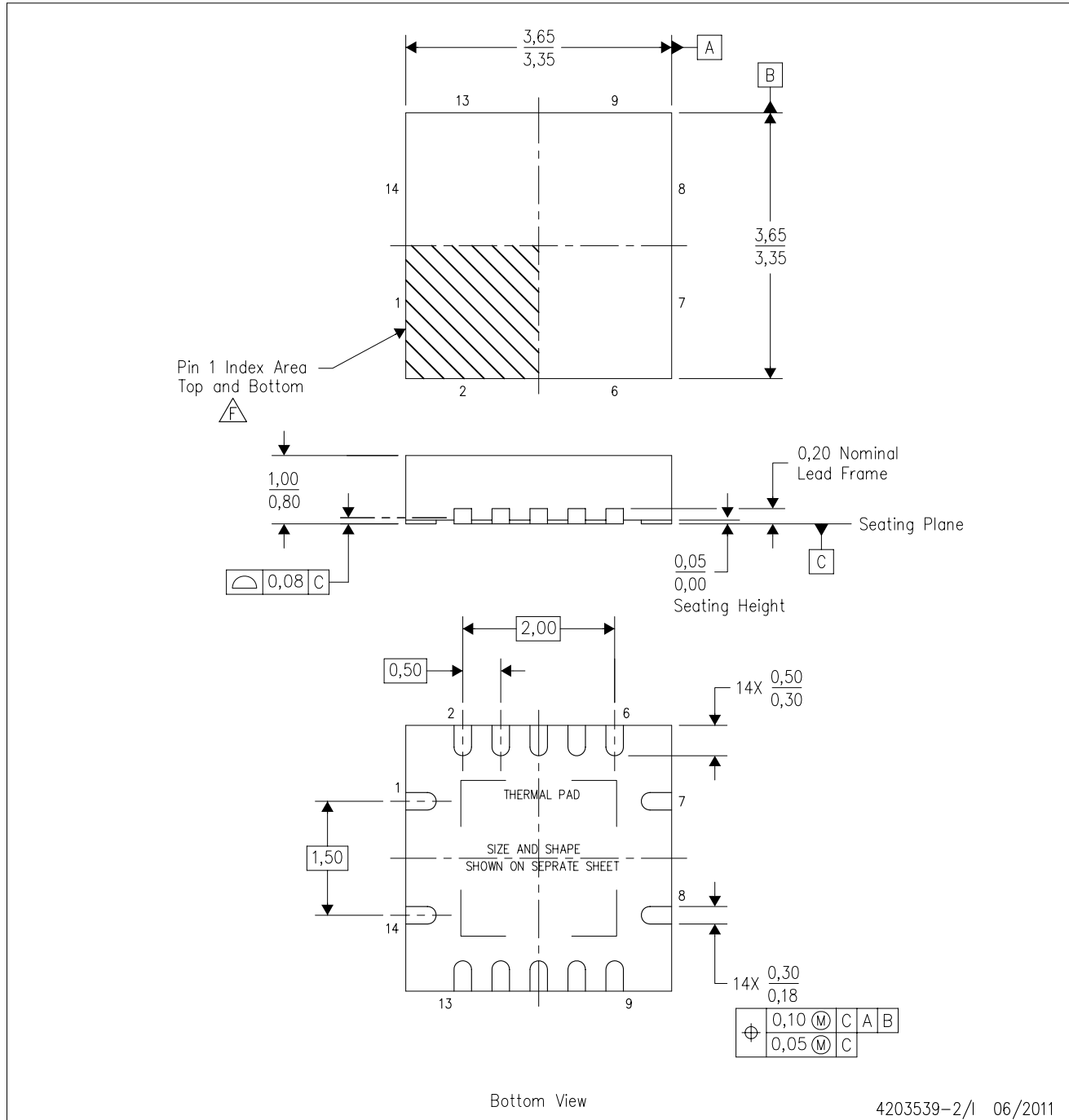
**TUBE**


\*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9681601Q2A | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| 5962-9681601QDA | W            | CFP          | 14   | 1   | 506.98 | 26.16  | 6220   | NA     |
| SN74AHC86N      | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74AHC86N      | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SNJ54AHC86FK    | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| SNJ54AHC86W     | W            | CFP          | 14   | 1   | 506.98 | 26.16  | 6220   | NA     |

RGY (S-PVQFN-N14)

PLASTIC QUAD FLATPACK NO-LEAD



- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - QFN (Quad Flatpack No-Lead) package configuration.
  - The package thermal pad must be soldered to the board for thermal and mechanical performance.
  - See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
  - Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
  - Package complies to JEDEC MO-241 variation BA.

RGY (S-PVQFN-N14)

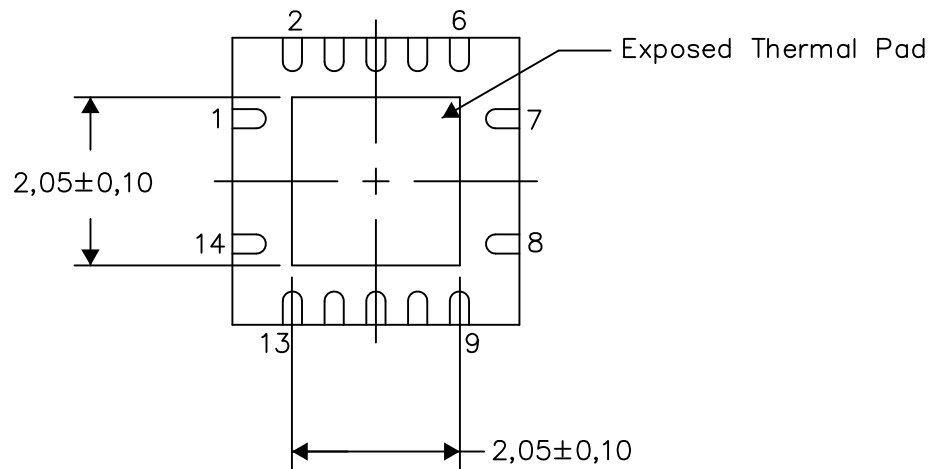
PLASTIC QUAD FLATPACK NO-LEAD

## THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.

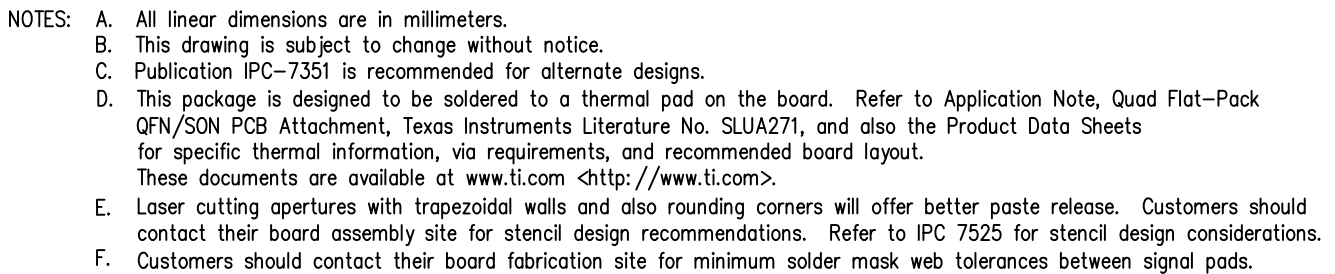


Bottom View

Exposed Thermal Pad Dimensions

4206353-2/P 03/14

NOTE: All linear dimensions are in millimeters



# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



## NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- This package can be hermetically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only.
- Falls within MIL STD 1835 GDFP1-F14

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

## GENERIC PACKAGE VIEW

**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4229370VA\

**J 14**

## GENERIC PACKAGE VIEW

**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G



**J0014A**

## PACKAGE OUTLINE

**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

### NOTES:

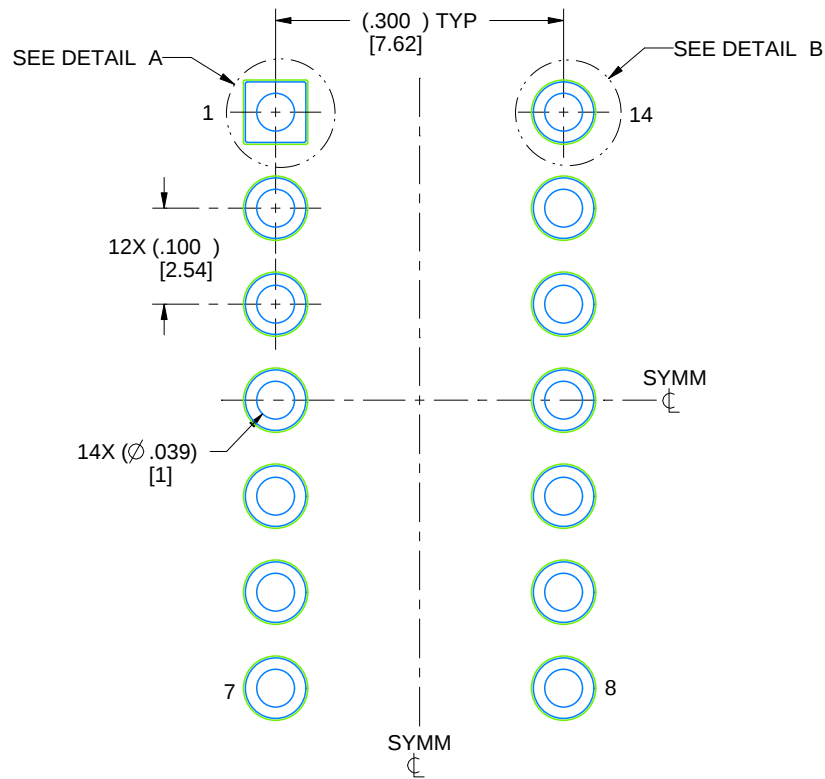
1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

# EXAMPLE BOARD LAYOUT

J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X



4214771/A 05/2017

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



4040047-5/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

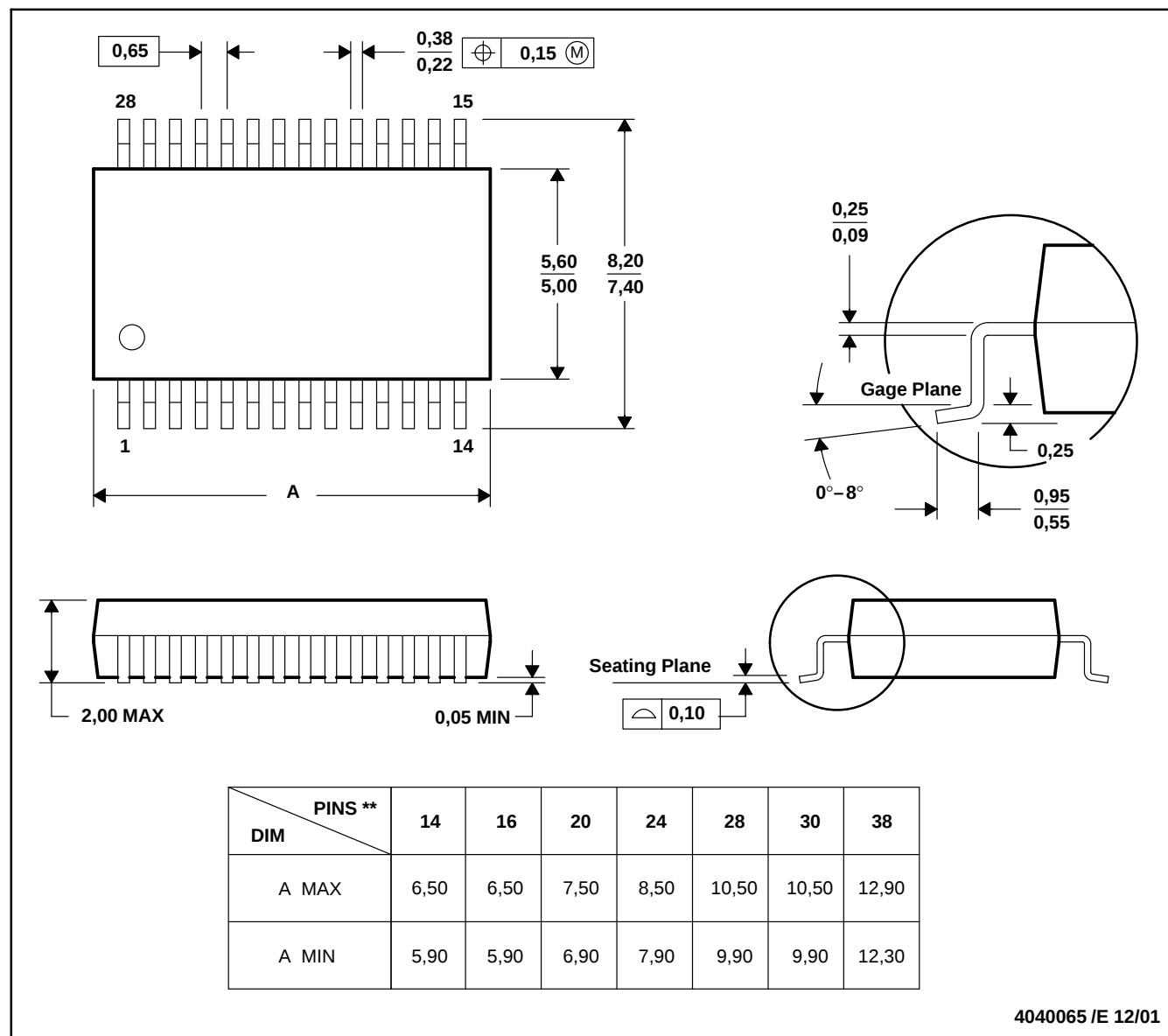
NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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